



YGF292N50 Grounding Plate

By Burndy
Catalog # YGF292N50

Compression Grounding Plate; Copper; 2-Hole;
Accommodates: #2 AWG - 250 kcmil; 1/2" Stud; 1-3/4" Stud
Hole Spacing; .94 EFF Thread.



General

Die Index	997
Material	Copper
Physical Attribute - Number of Crimps Required	2
Physical Attribute - Number of Tapped Holes	2
Plated	N
Plating Type	Unplated
Trade Name	HYGROUND®
UPC	781810220535
UPC 12 Digit	7818102205355

Dimensions

Dimension - D inch	3.25 in
Dimension - Height fraction	3-31/50 in
Dimension - Height inch	3.62 in
Dimension - L Length Overall mm	147 mm
Dimension - Length Overall inch	5.78 in
Dimension - Pad Width inch	2.00 in
Dimension - Thread Size	1/2-13
Dimension - Threads per inch	13
Physical Attribute - Tongue Angle	Straight

Conductor Related

Conductor - Copper Str Size	2 AWG;1 AWG;1/0 ;2/0 AWG;3/0 AWG;4/0 AWG;250 kcmil
Conductor - Copper Str Size Range	2 AWG-250 kcmil
Conductor Type	CU C Str-Size

Certifications and Compliance

Certification - CSA Approved	No
Certification - ETL	No
Certification - UL Listed Direct Burial	Yes
Certification - UL Recognized	No
Certification - cULus	No
Industry Standard(s)	NEMA Size Holes
Standards - Industry Standards Met	UL467;IEEE 837
Standards - RoHS Compliance Status	UI
UL Listed	No

Logistics

Minimum Pack Quantity	1
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Product Assets

[3D Models - YGF292N50_MODEL-PDF](#)
[3D Models - YGF292N50_MODEL-IGES](#)
[3D Models - YGF292N50_MODEL-STEP](#)



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